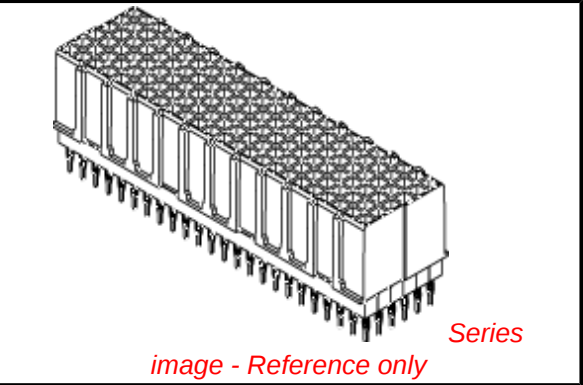


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Part Number: [0737801235](#)
Status: **Active**
Overview: [hdm](#)
Description: 2.00mm (.079") Pitch HDM® Board-to-Board Daughtercard Receptacle, Vertical, Signal Module, 144 Circuits, Mounted Height 15.00mm (.591"), Pin Length 2.00mm (.079"), Solder Tail



Documents:
[3D Model](#)
[Drawing \(PDF\)](#)
[Test Summary \(PDF\)](#)
[Product Specification PS-73780-999 \(PDF\)](#)
[RoHS Certificate of Compliance \(PDF\)](#)

General	
Product Family	Backplane Connectors
Series	73780
Application	Daughtercard, Mezzanine
Comments	Solder Tail
Component Type	PCB Receptacle
Overview	hdm
Product Name	HDM®
Style	N/A
Physical	
Circuits (Loaded)	144
Circuits (maximum)	144
Color - Resin	Black
Durability (mating cycles max)	250
First Mate / Last Break	No
Guide to Mating Part	No
Keying to Mating Part	None
Material - Metal	Copper-Nickel-Tin
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Number of Columns	24
Number of Pairs	Open Pin Field
Number of Rows	6
Orientation	Vertical
PC Tail Length (in)	0.098 In
PC Tail Length (mm)	2.50 mm
PCB Locator	No
PCB Retention	None
PCB Thickness Recommended (in)	0.063 In
PCB Thickness Recommended (mm)	1.60 mm
Packaging Type	Tube
Pitch - Mating Interface (in)	0.079 In
Pitch - Mating Interface (mm)	2.00 mm
Pitch - Term. Interface (in)	0.079 In
Pitch - Term. Interface (mm)	2.00 mm
Plating min: Mating (µin)	30
Plating min: Mating (µm)	0.75
Plating min: Termination (µin)	100
Plating min: Termination (µm)	2.5
Polarized to PCB	No
Stackable	Yes
Surface Mount Compatible (SMC)	Yes

EU RoHS
ELV and RoHS
Compliant
REACH SVHC
Contains SVHC: No
Halogen-Free
Status
Halogen-Free

China RoHS

Need more information on product environmental compliance?

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series
[73780Series](#)

Mates With
HDM® Board-to-Board Backplane Header [73642](#) , [73643](#) , [73644](#) , [73942](#) , [73943](#) , [73944](#) , [74349](#) , [74428](#). HDM® Board-to-Board Stacking Header [73769](#) , [73770](#) , [73782](#) , [73783](#) , [73771](#)

Temperature Range - Operating

Termination Interface: Style

-55°C to +105°C

Through Hole

Electrical

Current - Maximum per Contact

Data Rate

Real Signals (per 25mm)

Shielded

Voltage - Maximum

15A, 1A

1.0 Gbps

75

No

250V AC

Solder Process Data

Duration at Max. Process Temperature (seconds)

Lead-free Process Capability

Max. Cycles at Max. Process Temperature

Process Temperature max. C

5

Wave Capable (TH only)

1

260

Material Info

Reference - Drawing Numbers

Product Specification

Sales Drawing

PS-73780-999

SD-73780-004

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This document was generated on 05/14/2010

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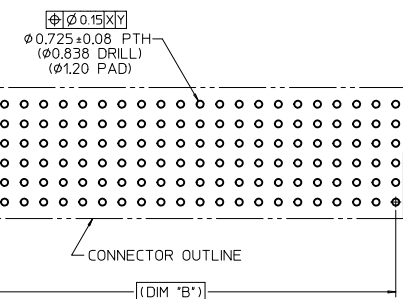


MATERIAL NUMBER ASSIGNMENT



NOTES:

1. MATERIALS: HOUSING - LIQUID CRYSTAL POLYMER (LCP), GLASS-FILLED, UL94V-0, COLOR: BLACK
2. FINISH: SELECTIVE GOLD (Au) IN CONTACT AREA, .76 MICROMETER MINIMUM THICKNESS, SELECTIVE TIN (Sn), 2.50 MINIMUM THICKNESS ON SOLDER TAILS, NICKEL (Ni) OVERALL.
3. THIS PART CONFORMS TO MOLEX PRODUCT SPECIFICATION PS-73780-999.
4. MARKINGS SHOWN FOR REFERENCE ONLY. SEE MATERIAL NUMBER ASSIGNMENT DIAGRAM FOR CORRECT NUMBER. MARKINGS TO INCLUDE MATERIAL NUMBER AND DATE CODE AND CAN BE LOCATED ANYWHERE ON PART, IN ANY ORIENTATION.
5. 73780-***7 AND -***0* PARTS TO BE PACKAGED IN TUBES PER PK-70873-0872. ALL OTHER PARTS TO BE PACKAGED IN TUBES PER PK-70873-0900.
6. 144-CIRCUIT HDM DAUGHTERCARD STACKING MODULE WITH PRESS-FIT TAILS SHOWN FOR ILLUSTRATION PURPOSES ONLY.
7. TRUE POSITION OF PC TAILS IS INSPECTED USING GAUGE NUMBER 73727-0014.
8. MARKINGS MAY BE ORIENTED TO EITHER SIDE OF CONNECTOR.



PCB LAYOUT: COMPONENT SIDE

73780-1***	144	48.17	46.00	47.6
73780-0***	72	24.17	22.00	23.6
MATERIAL NUMBER	CIRCUIT SIZE	DIM "A"	DIM "B"	DIM "C"

UPDATE TO S.T. ONLY IEC NO: UCP2010-1860 DRAWN: J. MELTON 2010/01/22 CHECKED: S. DANIELLEY 05/07/08 APPROVED: MILLER 2010/02/08 DESCRIPTION:		QUALITY SYMBOLS ▽=0 ▽=0 ▽=0		GENERAL TOLERANCES (UNLESS SPECIFIED) <table><thead><tr><th></th><th>mm</th><th>INCH</th></tr></thead><tbody><tr><td>4 PLACES ±</td><td>---</td><td>---</td></tr><tr><td>3 PLACES ±</td><td>---</td><td>---</td></tr><tr><td>2 PLACES ±</td><td>0.05</td><td>---</td></tr><tr><td>1 PLACE ±</td><td>0.10</td><td>---</td></tr><tr><td colspan="3">ANGULAR ± 2 °</td></tr></tbody></table> DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			mm	INCH	4 PLACES ±	---	---	3 PLACES ±	---	---	2 PLACES ±	0.05	---	1 PLACE ±	0.10	---	ANGULAR ± 2 °			DIMENSION STYLE MM ONLY DRAWN BY MIBARRA CHECKED BY BSMART APPROVED BY MILLER MATERIAL NO. DATE 05/07/08 DATE 05/07/08 DATE 2010/02/08		SCALE 4:1 DESIGN UNITS METRIC THIRD ANGLE PROJECTION TITLE SALES ASSEMBLY, HDM DAUGHTERCARD STACKING MODULE, SOLDER TAIL MOLEX INCORPORATED DOCUMENT NO. SD-73780-004 SHEET NO. 1 OF 1	
	mm	INCH																									
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REV		SIZE		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION																							

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